

Appl. No. 10/604,353
Amtd. Dated Aug. 17, 2004
Reply to Office Action of Jun. 7, 2004

Amendments to the Specification:

Applicant applied the present invention by Electronic Filing System, the system may result in mistakes during transmission. The original document in the attached appendix is provided for reviewing by Examiner.

[0001] Relevant subject matter is disclosed in pending U.S. Patent Applications with Ser. Nos. 10/840,989 filed May 7, 2004 and entitled "~~ELECTRICAL CONTACT AND METHOD OF MAKING THE SAME~~ CONNECTOR HAVING IMPROVED CONTACTS", and 10/602,247 entitled "~~ELECTRICAL CONNECTOR WITH IMPROVED COTANCT~~ RETENTION" filed on June 23, 2003, now U.S. Pat. No. 6,743,059, all both of which are invented by the same inventor as this patent application and assigned to the same assignee with this application.

Please replace paragraph [0023] with the following amended paragraph.

[0023] Referring to FIG. 3, each contact 2 comprises a flat contacting portion 21, a connecting portion 23 opposite to the contacting portion 21, and a retention portion 22 connecting the contacting portion 21 and the connecting portion 23. The retention portion 22 has a smaller width than the contacting portion 21, thus, a pair of shoulders 210 is formed on a rear edge of the contacting portion 21. A plurality of barbs 220 is formed on opposite sides of the retention portion 22. The connecting portion 23 includes ~~is formed into~~ a solder pad 230 to have a fusible substrate contact mass or body, such as a solder ball 5 (referring to FIG. 7), attached thereon.